Form PTO-1595 (Rev. 10/02) OMB No. 0651-0027 (exp. 6/30/2005) Tab settings ⇔ ⇔ ♥ ♥ ♥	U.S. DEPARTMENT OF COM U.S. Patent and Tradema 8,750
	ks: Please record the attached original documents or copy thereof
 Name of conveying party(ies): Hsin-Hui Lee Chien-Chao Huang Chao-Hsiung Wang Fu-Liang Yang and Chenming Hu Additional name(s) of conveying party(ies) attached? Yes v N 	2. Name and address of receiving party(ies) Name: <u>Taiwan Semiconductor Manufacturing</u> Internal Address: <u>Co., Ltd.</u>
3. Nature of conveyance: ✓ Assignment Security Agreement Other	Street Address: No. 8, Li-Hsin Road 6,
Execution Date: March 11, 16, 17, and 18,	- Additional name(s) & address(es) attached? Yes
Additional number	
Additional number 5. Name and address of party to whom correspondence concerning document should be mailed: Name:Howard Chen	s attached? Yes VNo
5. Name and address of party to whom correspondent concerning document should be mailed:	s attached? Yes V No
5. Name and address of party to whom correspondent concerning document should be mailed: Name:Howard Chen Internal Address: Duane Morris LLP	s attached? Yes VNo 6. Total number of applications and patents involv 7. Total fee (37 CFR 3.41)\$40.00 Enclosed
5. Name and address of party to whom correspondence concerning document should be mailed: Name:	s attached? Yes VNo Se 6. Total number of applications and patents involv 7. Total fee (37 CFR 3.41)\$40.00 Enclosed Authorized to be charged to deposit account 8. Deposit account number: 04-1679
5. Name and address of party to whom correspondent concerning document should be mailed: Name:Howard Chen Internal Address: Duane Morris LLP Street Address:	s attached? Yes Vo s attached? Yes Vo 6. Total number of applications and patents involv 7. Total fee (37 CFR 3.41)\$40.00 Enclosed Authorized to be charged to deposit account 8. Deposit account number:
5. Name and address of party to whom correspondence concerning document should be mailed: Name:Howard Chen Internal Address: Duane Morris LLP Street Address: Spear Tower, Suite 2000 City:_San Francisco State:_CA_Zip:_94105-1104 DO NOT U	s attached? Yes Vo Se 6. Total number of applications and patents involv 7. Total fee (37 CFR 3.41)\$40.00 Enclosed Authorized to be charged to deposit account 8. Deposit account number: 04-1679
5. Name and address of party to whom correspondence concerning document should be mailed: Name:Howard Chen Internal Address: Duane Morris LLP Street Address:One Market Street Spear Tower, Suite 2000 City:_San Francisco State:_CA_Zip:_94105-1104	s attached? Yes VNo Se 6. Total number of applications and patents involv 7. Total fee (37 CFR 3.41)\$40.00 Enclosed Authorized to be charged to deposit account 8. Deposit account number: 04-1679

PATENT REEL: 015149 FRAME: 0729

ASSIGNMENT AND AGREEMENT

For value received, I/we, Hsin-Hui Lee, Chien-Chao Huang, Chao-Hsiung Wang, Fu-Liang Yang and Chenming Hu, hereby sell, assign and transfer to Taiwan Semiconductor Manufacturing Co., Ltd., with its principal place of business located at No. 8, Li-Hsin Road 6, Science-Based Industrial Park, Hsin-Chu, Taiwan 300-77, Republic of China, and its successors, assigns and legal representatives, the entire right, title and interest, for the United States of America, in and to certain inventions related to METHOD FOR DICING SEMICONDUCTOR WAFERS described in an application for Letters Patent of the United States and all the rights and privileges in said application and under any and all Letters Patent and any divisions, continuations, continuations-in-part, reexamination certificates, reissues, and

extensions thereof that may be granted in the United States for said inventions; and I also concurrently hereby sell, assign and transfer to Taiwan Semiconductor Manufacturing Co., Ltd. the entire right, title and interest in and to said inventions for all countries foreign to the United States, including all rights of priority arising from the application aforesaid, and all the rights and privileges under any and all forms of protection, including Letters Patent, that may be granted in said countries foreign to the United States for said inventions.

I/we authorize Taiwan Semiconductor Manufacturing Co., Ltd. to make application for such protection in its own name and maintain such protection in any and all countries foreign to the United States, and to invoke and claim for any application for patent or other form of protection for said inventions, without further authorization from us, any and all benefits, including the right of priority provided by any and all treaties, conventions, or agreements.

I/we hereby consent that a copy of this assignment shall be deemed a full legal and formal equivalent of any document which may be required in any country in proof of the right of Taiwan Semiconductor Manufacturing Co., Ltd. to apply for patent or other form of protection for said inventions and to claim the aforesaid benefit of the right of priority.

I/we request that any and all patents for said inventions be issued to Taiwan Semiconductor Manufacturing Co., Ltd. in the United States and in all countries foreign to the United States, or to such nominees as Taiwan Semiconductor Manufacturing Co., Ltd. may designate.

I/we agree that, when requested, I/we shall, without charge to Taiwan Semiconductor Manufacturing Co., Ltd. but at its expense, sign all papers, and do all acts which may be necessary, desirable or convenient in connection with said applications, patents, or other forms of protection.

Assignment and Agreement 1

PATENT REEL: 015149 FRAME: 0730

ATTORNEY DOCKET NO. N1280-00320(TSMC2003-1469)

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Assignment and Agreement 2

RECORDED: 03/29/2004